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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)
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SILICON POWER TRANSISTOR 2SC4815

NPN SILICON EPITAXIAL TRANSISTOR FOR HIGH-SPEED SWITCHING

The 2SC4815 is a power transistor developed for high-speed switching and features low VcE(sat) and high here. This transistor is ideal for use as a driver in DC/DC converters and actuators.

In addition, this transistor is available for the auto mount in the radial taping specifications and for mounting cost reduction.

FEATURES

• High hre and low VCE(sat):

 $V_{CE(sat)} \le 0.3 \text{ V}$ @ Ic = 3.0 A, IB = 0.15 A $h_{FE} \ge 100$ @ $V_{CE} = 2.0 \text{ V}$, Ic = 1.0 A

· Available for auto mount in radial taping specifications

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vcво	100	V
Collector to emitter voltage	VCEO	60	V
Emitter to base voltage	V _{EBO}	7.0	V
Collector current (DC)	Ic(DC)	5.0	Α
Collector current (pulse)	I _{C(pulse)} *	10	Α
Base current (DC)	I _{B(DC)}	2.5	Α
Total power dissipation	Рт	1.8	W
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

^{*} PW \leq 300 μ s, duty cycle \leq 10%

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector to emitter voltage	VCEO(SUS)	Ic = 5.0 A, Iв = 0.5 A, L = 1 mH	60			٧
Collector to emitter voltage	VCEX(SUS)	Ic = 2.5 A, I _{B1} = $-I_{B2}$ = 0.25 A V _{BE(OFF)} = -1.5 V, L = 180 μ H, Clamped	60			V
Collector cutoff current	Ісво	Vcb = 100 V, IE = 0			10	μΑ
Emitter cutoff current	Ієво	V _{EB} = 7.0 V, I _C = 0			10	μΑ
DC current gain	h _{FE1} *	Vce = 2.0 V, Ic = 0.5 A	100			
DC current gain	h _{FE2} *	Vce = 2.0 V, Ic = 1.0 A	100	200	400	
DC current gain	h _{FE3} *	Vce = 2.0 V, Ic = 3.0 A	60			
Collector saturation voltage	V _{CE(sat)1} *	Ic = 3.0 A, Iв = 0.15 A		0.15	0.3	٧
Collector saturation voltage	V _{CE(sat)2} *	Ic = 4.0 A, I _B = 0.2 A		0.3	0.5	٧
Base saturation voltage	V _{BE(sat)1} *	Ic = 3.0 A, Iв = 0.15 A		0.9	1.2	٧
Base saturation voltage	V _{BE(sat)2} *	Ic = 4.0 A, I _B = 0.2 A		1.2	1.5	٧
Collector capacitance	Соь	Vcb = 10 V, IE = 0 , f = 1.0 MHz		70		pF
Gain bandwidth product	f⊤	Vce = 10 V, Ic = 0.5 A		150		MHz
Turn-on time	ton	Ic = 3.0 A, R _L = 17 Ω ,		0.1		μs
Storage time	tstg	$I_{B1} = -I_{B2} = 0.15 \text{ A}, V_{CC} \cong 50 \text{ V}$ Refer to the test circuit.		1.0		μs
Fall time	tf	neier to the test circuit.		0.25		μs

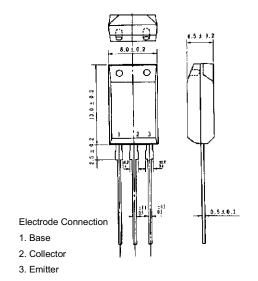
^{*} Pulse test PW \leq 350 μ s, duty cycle \leq 2%

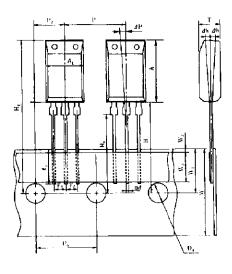
hfe CLASSIFICATION

Marking	М	L	К	
hFE2	100 to 200	150 to 300	200 to 400	

PACKAGE DRAWING (UNIT: mm)

TAPING SPECIFICATION

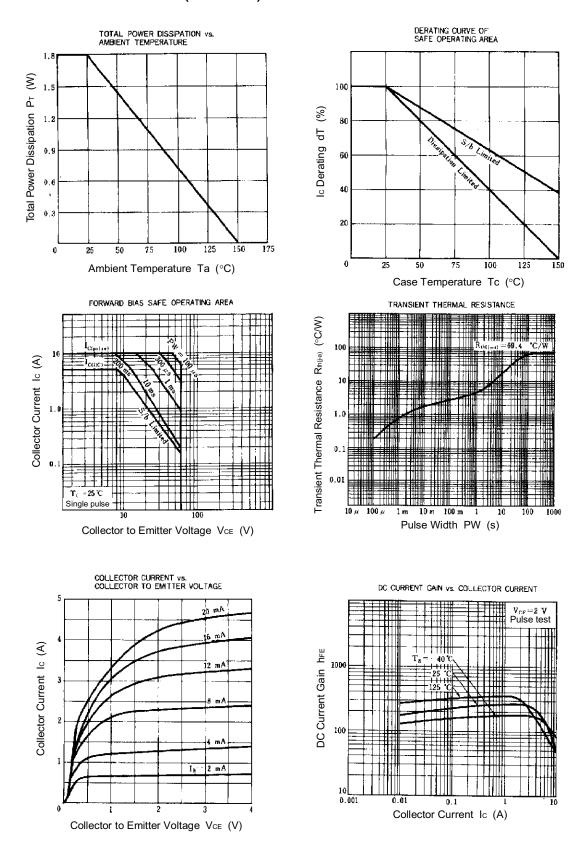




A_1	8.0±0.2
A	13.0±0.2
D_0	Ø4.0±0.2
d	0.5±0.1
\mathbf{F}_1	2.5.0.4
\mathbf{F}_{z}	2.5+0.4
H	20.0 MAX.
Ho	16.0±0.5
$\mathbf{H_1}$	32.2 MAX.
⊿h	0±1.0
Ł ₁	2.5 MIN.
P	12.7 ± 1.0
P_0	12.7 ± 0.3
P_2	6.35±0.5
ΔP	0±1.3
T	4.5±0.2
W	18.0+1.0
W ₀	5.0 MIN.
\mathbf{W}_1	9.0±0.5
W ₂	0.7 or less
	<u> </u>

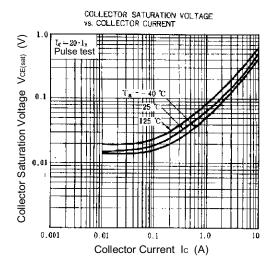


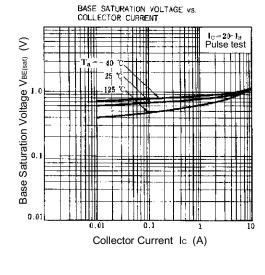
TYPICAL CHARACTERISTICS (Ta = 25°C)

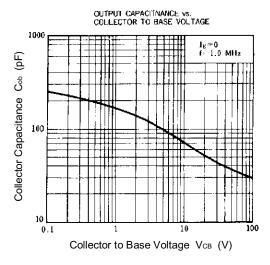


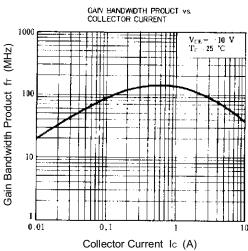
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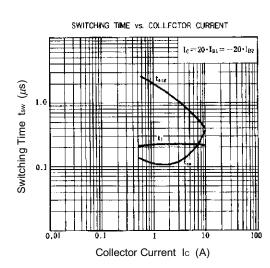
3





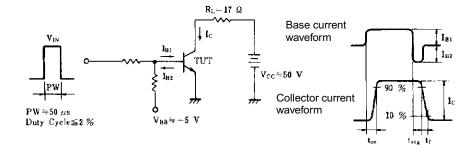








SWITCHING TIME (ton, tstg, tf) TEST CIRCUIT



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